



# Product Change Notification

**Change Notification #:** 118347-00  
**Change Title:** Select Intel® SSD D7-P5510 Series, PCN 118347-00, Label, UKCA and Hot Caution Label Update  
**Date of Publication:** July 01, 2021

**Key Characteristics of the Change:**  
 Label

### Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	July 31, 2021
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### Description of Change to the Customer:

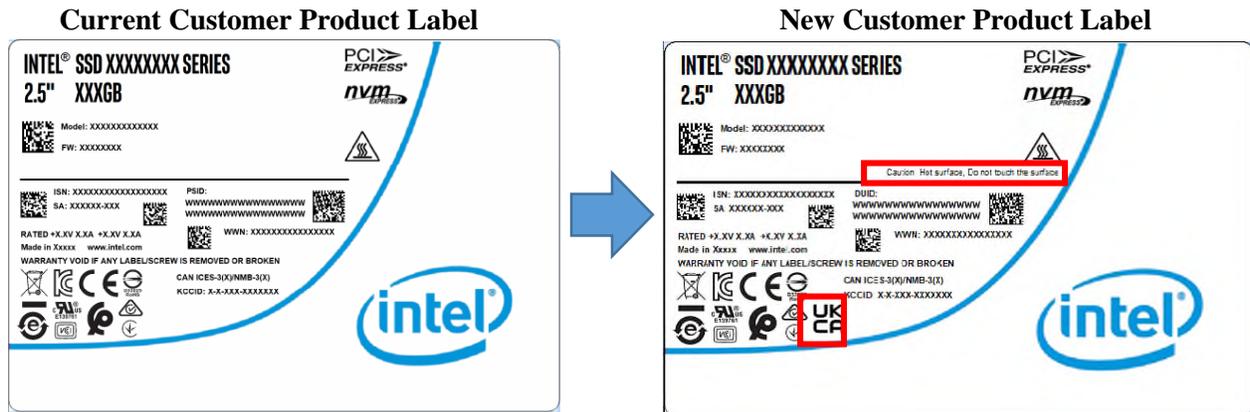
The Intel® D7-P5510 Series SKUs listed in the products affected table will have the following changes.

- Change 1: Customer Label (Adding UKCA Marking and Hot Caution Text)
- Change 2: Distri box Label (Adding UKCA and Intel Address)
- Change 3: Update current on Label

Change 1 & 3 SKUs Only	
Product Code	MM#
SSDPF2KX038TZ	99AJR9
SSDPF2KX076TZ	99AJRA

Change 1, 2, 3 SKUs	
Product Code	MM#
SSDPF2KX038TZOS	99A5CZ
SSDPF2KX076TZOS	99A5D1
SSDPF2KX038TZ01	99A5DP
SSDPF2KX076TZ01	99A5DR

### Change 1: Customer Label (Adding UKCA Marking and Hot Caution Text)



## Change 2: Disti box Label (Adding UKCA and Intel Address)



## Change 3: Update current on Label

### Current update:

	AS IS	To BE
<b>3.84 TB</b>	+3.3V <b>10mA</b> , +12V 1.15A	+3.3V <b>5mA</b> , +12V 1.15A
<b>7.68 TB</b>	+3.3V <b>10mA</b> , +12V 1.4A	+3.3V <b>5mA</b> , +12V 1.4A

## Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product. The change is only to the labels used in packaging. Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD D7-P5510 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack OPAL	SSDPF2KX038TZOS	99A5CZ
Intel® SSD D7-P5510 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack OPAL	SSDPF2KX076TZOS	99A5D1
Intel® SSD D7-P5510 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack	SSDPF2KX038TZ01	99A5DP
Intel® SSD D7-P5510 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack	SSDPF2KX076TZ01	99A5DR
Intel® SSD D7-P5510 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Multiple Pack	SSDPF2KX038TZ	99AJR9
Intel® SSD D7-P5510 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Multiple Pack	SSDPF2KX076TZ	99AJRA

**PCN Revision History:**

**Date of Revision:**

July 01, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 118347-00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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